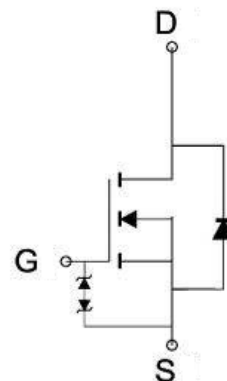
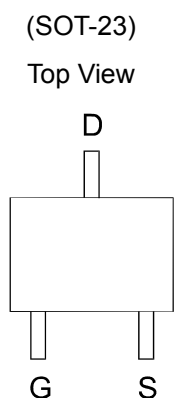


**N-Channel 50V (D-S) MOSFET, ESD Protection**
**GENERAL DESCRIPTION**

The MEBSS138D is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits and low in-line power loss are needed in a very small outline surface mount package.

**PIN CONFIGURATION**

**N-Channel MOSFET**
**Ordering Information:**MEBSS138D (Pb-free)

MEBSS138D-G (Green product-Halogen free)

**Absolute Maximum Ratings (TA=25°C Unless Otherwise Noted)**

Parameter	Symbol	Maximum Ratings	Unit
Drain-Source Voltage	V <sub>DS</sub>	50	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current	I <sub>D</sub>	TA=25°C	0.25
		TA=70°C	0.2
Pulsed Drain Current	I <sub>DM</sub>	1	A
Maximum Power Dissipation	P <sub>D</sub>	TA=25°C	0.36
		TA=70°C	0.23
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to 150	°C
Thermal Resistance-Junction to Ambient*	R <sub>θJA</sub>	350	°C/W

 \*The device mounted on 1in<sup>2</sup> FR4 board with 2 oz copper

**FEATURES**

- R<sub>DS(ON)</sub> ≤ 3.5Ω@V<sub>GS</sub>=10V
- R<sub>DS(ON)</sub> ≤ 4Ω@V<sub>GS</sub>=4.5V
- Super high density cell design for extremely low R<sub>DS(ON)</sub>
- Exceptional on-resistance and maximum DC current capability

**APPLICATIONS**

- Power Management in Note book
- DC/DC Converter
- Load Switch
- LCD Display inverter



**N-Channel 50V (D-S) MOSFET, ESD Protection**
**Electrical Characteristics** ( $T_A=25^\circ\text{C}$  Unless Otherwise Specified)

Symbol	Parameter	Limit	Min	Typ	Max	Unit
<b>STATIC</b>						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\ \mu A$	50			V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=1mA$	0.5		1.5	V
$I_{GSS}$	Gate Leakage Current	$V_{DS}=0V, V_{GS}=\pm 20V$			$\pm 10$	$\mu A$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=50V, V_{GS}=0V$			1	$\mu A$
$R_{DS(ON)}$	Drain-Source On-Resistance <sup>a</sup>	$V_{GS}=10V, I_D=200mA$		2.5	3.5	$\Omega$
		$V_{GS}=4.5V, I_D=200mA$		3.1	4	
$V_{SD}$	Diode Forward Voltage	$I_S=0.44A, V_{GS}=0V$		0.8	1.4	V
<b>DYNAMIC</b>						
$Q_g$	Total Gate Charge	$V_{DS}=25V, V_{GS}=10V, I_D=0.22A$		4.7		nC
$Q_{gs}$	Gate-Source Charge			1.7		
$Q_{gd}$	Gate-Drain Charge			0.8		
$C_{iss}$	Input Capacitance	$V_{DS}=25V, V_{GS}=0V, f=1MHz$		33		pf
$C_{oss}$	Output Capacitance			25		
$C_{rss}$	Reverse Transfer Capacitance			13		
$t_{d(on)}$	Turn-On Delay Time	$V_{DD}=5V, R_L=500\ \Omega,$ $V_{GEN}=5V, R_G=10\ \Omega$		10.1		ns
$t_r$	Turn-On Rise Time			7.3		
$t_{d(off)}$	Turn-Off Delay Time			31.3		
$t_f$	Turn-Off Fall Time			28.2		

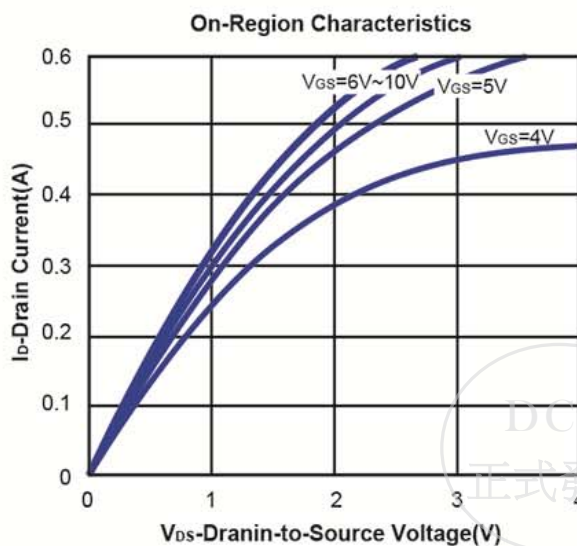
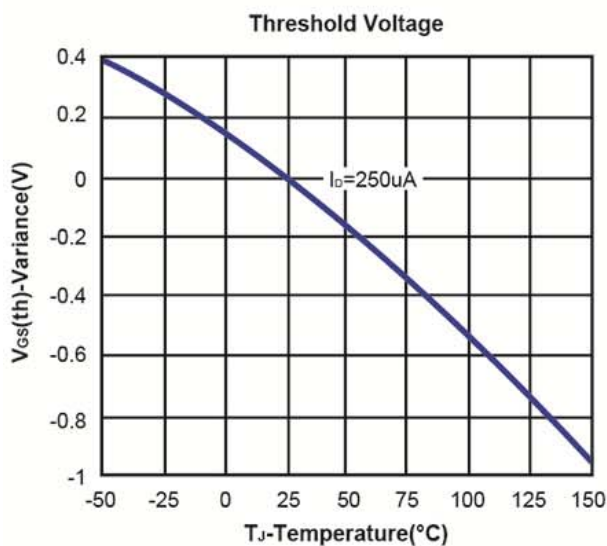
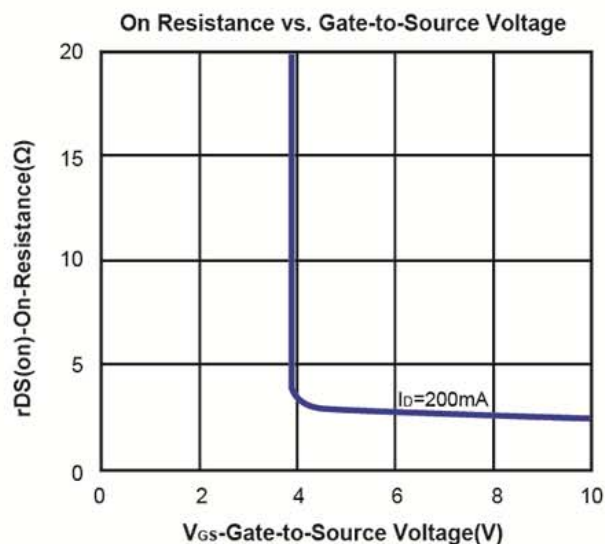
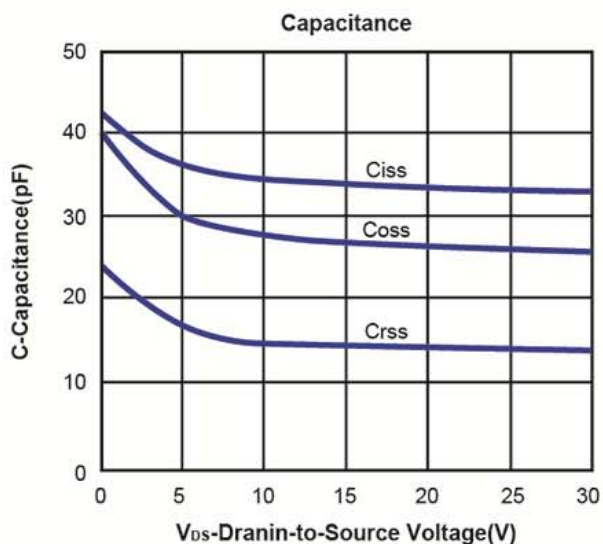
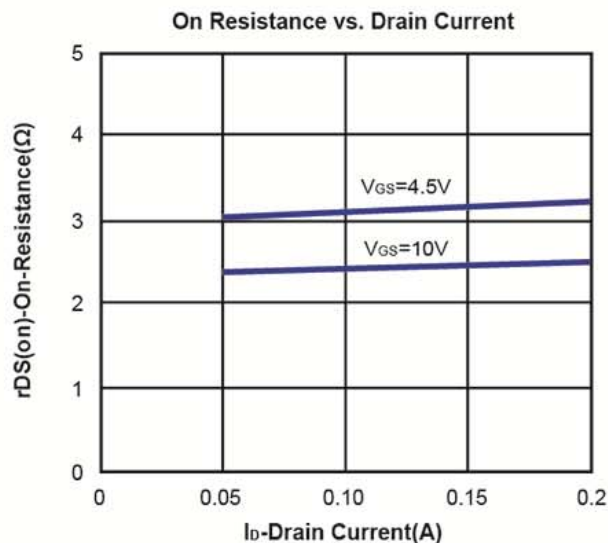
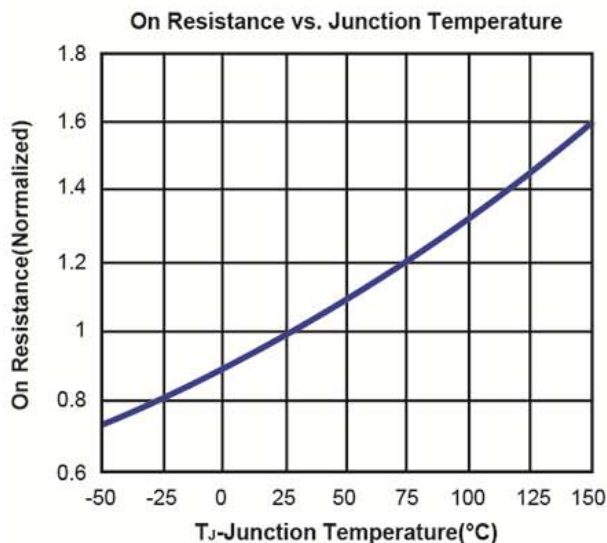
 Notes: a. Pulse test: pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ , Guaranteed by design, not subject to production testing.

b. Matsuki Electric/ Force mos reserves the right to improve product design, functions and reliability without notice.



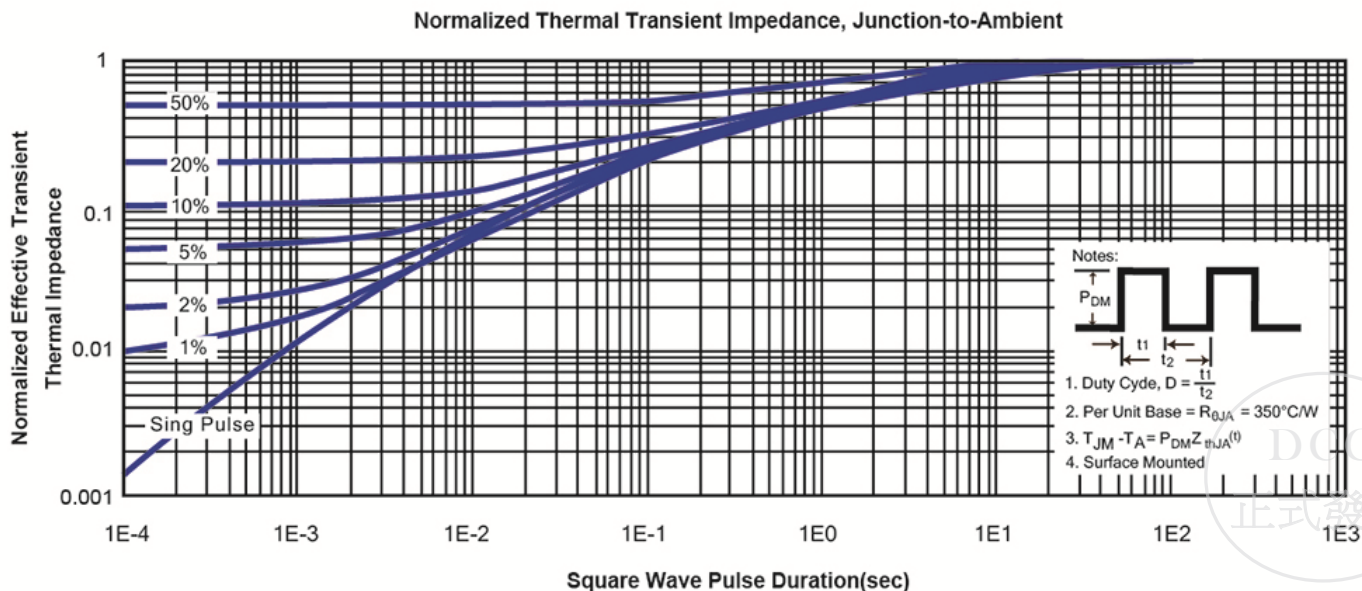
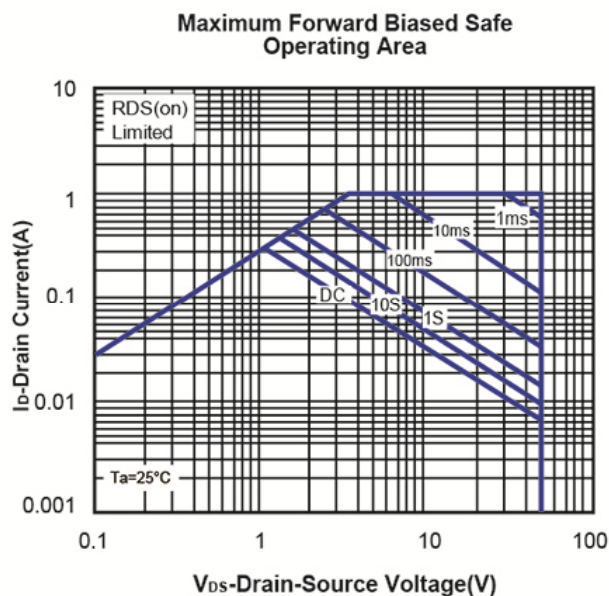
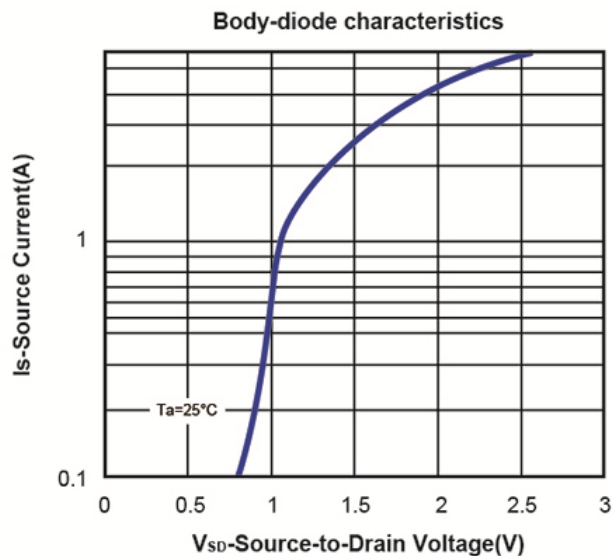
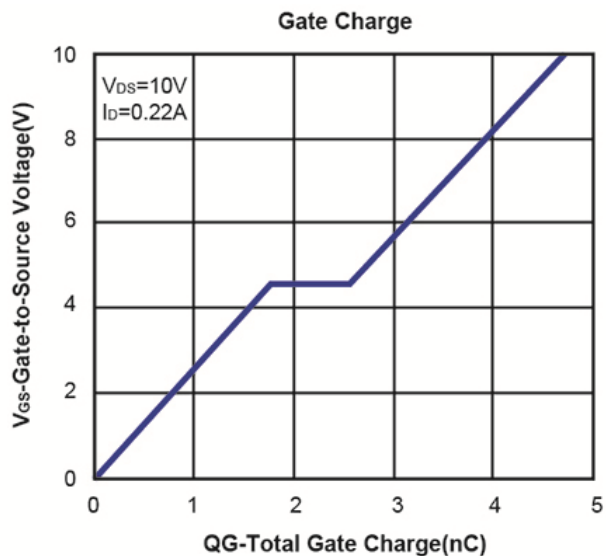
**N-Channel 50V (D-S) MOSFET, ESD Protection**

**Typical Characteristics (T<sub>J</sub> = 25°C Noted)**

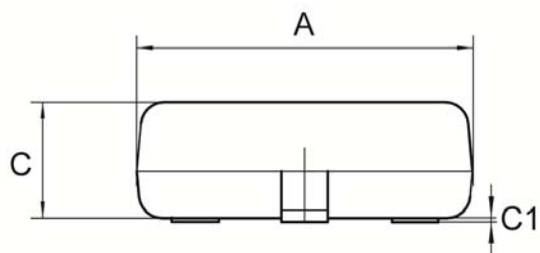
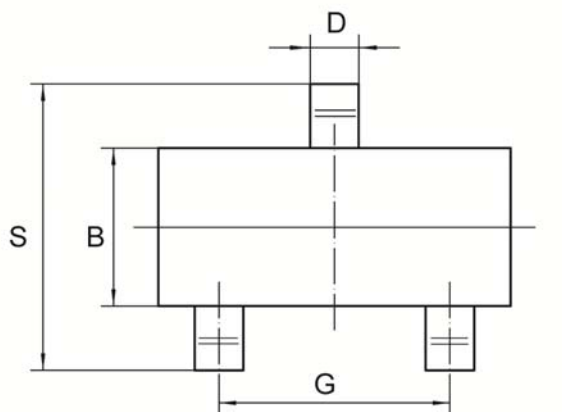


N-Channel 50V (D-S) MOSFET, ESD Protection

Typical Characteristics (T<sub>J</sub> = 25°C Noted)



**SOT-23 Package Outline**



Symbol	MILLIMETERS	
	MIN	MAX
A	2.8	3.0
B	1.2	1.4
C	0.9	1.1
C1	-	0.1
D	0.3	0.5
G	1.90 REF	
J	0.05	0.15
K	0.2	-
S	2.2	2.6

